## BTB08-600BW3G, BTB08-800BW3G





# <u>Features</u>

**Description** 

• Blocking Voltage to 800 V

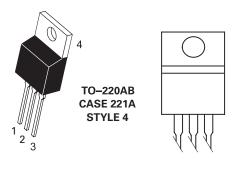
commutating di/dt are required.

• On-State Current Rating of 12 Amperes RMS at 25°C

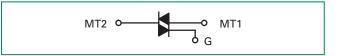
Designed for high performance full-wave ac control applications where high noise immunity and high

- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 2000 V/µs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dl/dt 4. A/ms minimum at 125°C
- These are Pb-Free Devices

#### **Pin Out**



#### **Functional Diagram**



### **Additional Information**







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Specifications are subject to change without notice.
Revised: 08/30/17

### **Maximum Ratings** $(T_j = 25^{\circ}C \text{ unless otherwise noted})$

Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) (Gate Open, Sine Wave 50 to 60 Hz, $T_J$ = -40° to 150°C) BTB08–600BW3G BTB08–800BW3G	V <sub>DRM</sub> , V <sub>RRM</sub>	600 800	V
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, $T_{\rm C}$ = 80°C)	I <sub>T (RMS)</sub>	12	А
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, T <sub>c</sub> = 25°C)	I <sub>TSM</sub>	125	А
Circuit Fusing Consideration (t = 8.3 ms)	l²t	78	A²sec
Non-Repetitive Surge Peak Off-State Voltage (T <sub>J</sub> = 25°C, t = 10 ms)	V <sub>DSM</sub> /V <sub>RSM</sub>	V <sub>DSM</sub> /V <sub>RSM</sub> +100	V
Peak Gate Current ( $T_J = 125$ °C, t = 20ms)	I <sub>GM</sub>	4.0	W
Peak Gate Power (Pulse Width $\leq$ 1.0 $\mu$ s, $T_{c}$ = 80°C)	P <sub>GM</sub>	20	W
Average Gate Power ( $T_J = 125^{\circ}C$ )	P <sub>G(AV)</sub>	1.0	W
Operating Junction Temperature Range	T <sub>J</sub>	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +125	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### **Thermal Characteristics**

Rating		Symbol	Value	Unit
Thermal Resistance,	Junction-to-Case (AC)	R <sub>sJC</sub>	2.5	°C/W
	Junction-to-Ambient	R <sub>sJA</sub>	60	C/VV
Maximum Lead Temperature for Sol 10 seconds	dering Purposes, 1/8" from case for	T <sub>L</sub>	260	°C

<sup>1.</sup> V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Ratings apply for zero or negative gate voltage; however, positive gate voltage shall not be applied concurrent with negative potential on the anode. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



### Surface Mount - 800V > BTB08-600BW3G, BTB08-800BW3G

### **Electrical Characteristics** • **OFF** (T<sub>1</sub> = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Peak Repetitive Blocking Current	$T_{_{\rm J}}=25^{\circ}{\rm C}$	I <sub>DRM</sub> ,	-	-	0.005	
$(V_D = V_{DRM} = V_{RRM}; Gate Open)$	$T_J = 125^{\circ}C$	I <sub>RRM</sub>	-	-	1.0	j mA

### **Electrical Characteristics - ON** (T<sub>j</sub> = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic		Symbol	Min	Тур	Max	Unit
Forward On-State Voltage (Note 2) ( $I_{TM} = \pm 17 \text{ A Peak}$ )	Forward On-State Voltage (Note 2) ( $I_{TM} = \pm 17 \text{ A Peak}$ )		-	_	1.55	V
Gate Trigger Current (Continuous dc) ( $V_D = 12 \text{ V}, R_L = 30 \Omega$ )	MT2(+), G(+)		2.5	-	50	
	MT2(+), G(-)	l <sub>GT</sub>	2.5	-	50	mA
	MT2(-), G(-)		2.5	_	50	
Holding Current $(V_D = 12 \text{ V, Gate Open, Initiating Current} = \pm 100 \text{ mA})$		I <sub>H</sub>	-	_	50	mA
	MT2(+), G(+)		-	_	70	
Latching Current ( $V_D = 24 \text{ V}, I_G = 60 \text{ mA}$ )	MT2(+), G(-)	I <sub>L</sub>	-	-	90	mA
	MT2(-), G(-)		-	_	70	
	MT2(+), G(+)		0.5	-	1.7	
Gate Trigger Voltage ( $V_D = 12 \text{ V}, R_L = 30 \Omega$ )	MT2(+), G(-)	V <sub>GT</sub>	0.5	_	1.1	V
	MT2(-), G(-)		0.5	-	1.1	
	MT2(+), G(+)		0.2	-	-	
Gate Non-Trigger Voltage (T <sub>J</sub> = 125°C)	MT2(+), G(-)	$V_{\rm GD}$	0.2	-	-	V
	MT2(-), G(-)		0.2	_	-	

<sup>2.</sup> Indicates Pulse Test: Pulse Width  $\leq$  2.0 ms, Duty Cycle  $\leq$  2% .



### Surface Mount - 800V > BTB08-600BW3G, BTB08-800BW3G

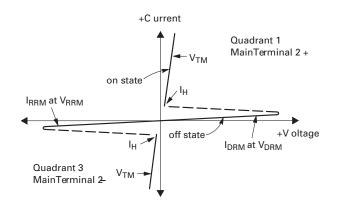
### **Dynamic Characteristics**

Characteristic	Symbol	Min	Тур	Max	Unit
Rate of Change of Commutating Current, See Figure 10. (Gate Open, T <sub>J</sub> = 125°C, No Snubber)	(dl/dt)c	4.0	-	-	A/ms
Critical Rate of Rise of On–State Current ( $T_J = 125$ °C, $f = 120$ Hz, $I_G = 2 \times I_{GT}$ , tr $\leq 100$ ns)	dl/dt	-	-	50	A/μs
Critical Rate of Rise of Off-State Voltage $(V_D = 0.66 \times V_{DRM'})$ Exponential Waveform, Gate Open, $T_J = 125$ °C)	dV/dt	2000	-	-	V/µs

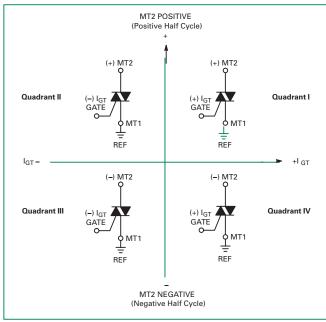
#### **Voltage Current Characteristic of SCR**

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current

**Thyristors** 

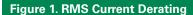


### **Quadrant Definitions for a Triac**



All polarities are referenced to MT1.
With in-phase signals (using standard AC lines) quadrants I and III are used





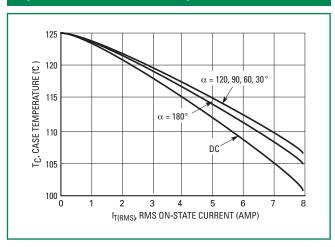
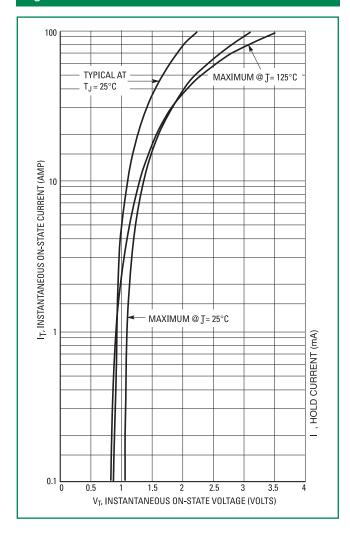


Figure 3. On-State Characteristics



**Figure 2. On-State Power Dissipation** 

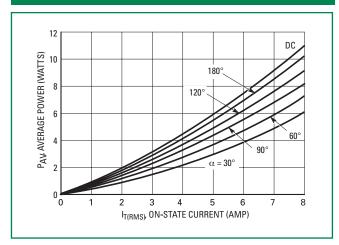


Figure 4. Thermal Response

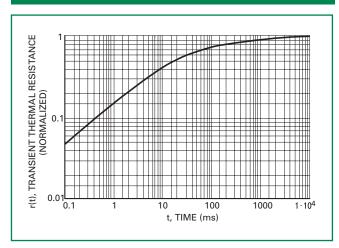
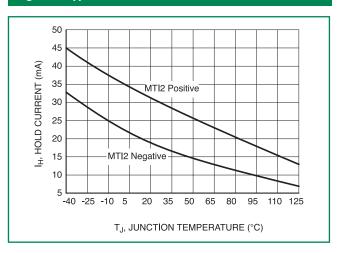


Figure 5. Typical Hold Current Variation







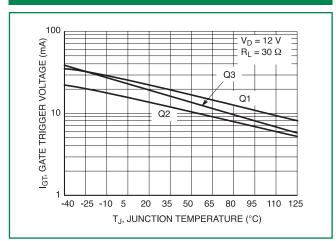


Figure 7. Typical Gate Trigger Voltage Variation

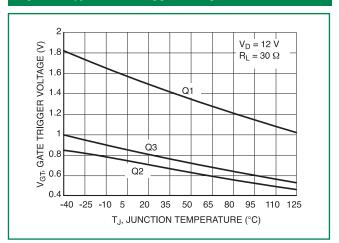


Figure 8. Critical Rate of Rise of Off-State Voltage (Exponential Waveform)

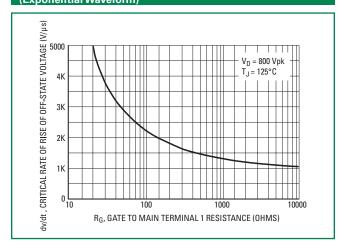
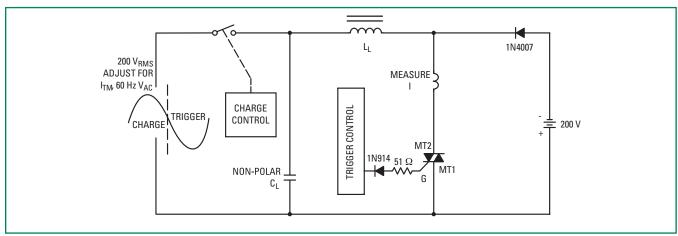


Figure 9. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)

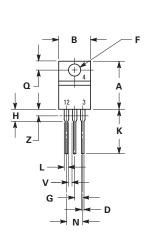


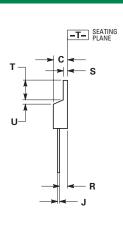
Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information



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#### **Dimensions**



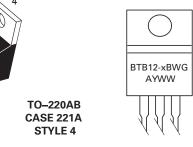


	Inches		Millim	neters	
Dim	Min	Max	Min	Max	
А	0.570	0.620	14.48	15.75	
В	0.380	0.405	9.66	10.28	
С	0.160	0.190	4.07	4.82	
D	0.025	0.035	0.64	0.88	
F	0.142	0.147	3.61	3.73	
G	0.095	0.105	2.42	2.66	
Н	0.110	0.155	2.80	3.93	
J	0.014	0.022	0.36	0.55	
K	0.500	0.562	12.70	14.27	
L	0.045	0.060	1.15	1.52	
N	0.190	0.210	4.83	5.33	
Q	0.100	0.120	2.54	3.04	
R	0.080	0.110	2.04	2.79	
S	0.045	0.055	1.15	1.39	
Т	0.235	0.255	5.97	6.47	
U	0.000	0.050	0.00	1.27	
V	0.045		1.15		
Z		0.080		2.04	

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

### **Part Marking System**





x= 6 or 8

A= Assembly Location

Year

WW = Work Week
G= Pb-Free Package

Pin Assignment	
1	Main Terminal 1
2	Main Terminal 2
3	Gate
4	Main Terminal 2

### **Ordering Information**

Device	Package	Shipping
BTB08-600BW3G	TO-220AB (Pb-Free)	50 Units / Rail
BTB08-800BW3G	TO-220AB (Pb-Free)	50 Units / Rail

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